

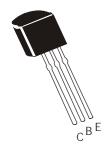
Continental Device India Limited

An ISO/TS 16949, ISO 9001 and ISO 14001 Certified Company





NPN SILICON PLANAR EPITAXIAL TRANSISTORS



BC237,238, A,B,C BC239, B,C

TO-92
Plastic Package
For Lead Free Parts, Device
Part # will be Prefixed with

Amplifier Transistors

ABSOLUTE MAXIMUM RATINGS (T_a=25°C)

DESCRIPTION	SYMBOL	BC237	BC238	BC239	UNITS
Collector Emitter Voltage	V_{CEO}	45	25	25	V
Collector Emitter Voltage	V _{CES}	50	30	30	V
Emitter Base Voltage	V_{EBO}	6.0	5.0	5.0	V
Collector Current Continuous	I _C	100			mA
Power Dissipation at T _a =25ºC	P _D	350			mW
Derate Above 25°C		2	mW/ºC		
Power Dissipation at T _c =25ºC	P _D	1.0			W
Derate Above 25ºC		8.0			mW/ºC
Operating And Storage Junction Temperature Range	T _j , T _{stg}	- 55 to +150			°C

THERMAL RESISTANCE

Junction to Ambient in free air	R _{th (j-a)}	357	°C/W
Junction to Case	R _{th (i-c)}	125	°C/W

ELECTRICAL CHARACTERISTICS (T_a=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	MAX	UNITS
Collector Emitter Voltage	V _{CEO}	$I_C=2mA$, $I_B=0$			
		BC237	45		V
		BC238/BC239	25		V
Emitter Base Voltage	V _{EBO}	$I_{E}=10\mu A, I_{C}=0$			
		BC237	6.0		V
		BC238/BC239	5.0		V
Collector Cut Off Current	I _{CES}	BC238/BC239		15	nA
		V_{CE} =30V, V_{BE} =0			
		BC237		15	nA
		V_{CE} =50V, V_{BE} =0			
		BC238/BC239		4.0	μΑ
		V_{CE} =30V, V_{BE} =0, Ta=125°C			
		BC237		4.0	μΑ
		V _{CE} =50V, V _{BE} =0, Ta=125°C			

NPN SILICON PLANAR EPITAXIAL TRANSISTORS

C_{BE}

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ELECTRICAL CHARACTERISTICS (T_a=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	MAX	UNITS
DC Current Gain	h _{FE}	$I_C=10\mu A, V_{CE}=5V$			
		Α	TYF	90	
		В	TYP	150	
		С	TYF	270	
		$I_C=2mA$, $V_{CE}=5V$			
		BC237/238/239	120	800	
		Α	120	220	
		В	200	460	
		С	380	800	
		$^*I_C=100$ mA, $V_{CE}=5$ V			
		Α	TYF	120	
		В	TYF	180	
		С	TYF	300	
Collector Emitter Saturation Voltage	V _{CE (sat)}	$I_C=10$ mA, $I_B=0.5$ mA		0.20	V
		*I_C =100mA, I_B =5mA			
		BC237/239		0.60	V
		BC238		0.80	V
Base Emitter Saturation Voltage	V _{BE (sat)}	$I_C=10$ mA, $I_B=0.5$ mA		0.83	V
		*I_C =100mA, I_B =5mA		1.05	V
Base Emitter On Voltage	V _{BE (on)}	$I_C=2mA$, $V_{CE}=5V$	0.55	0.70	V

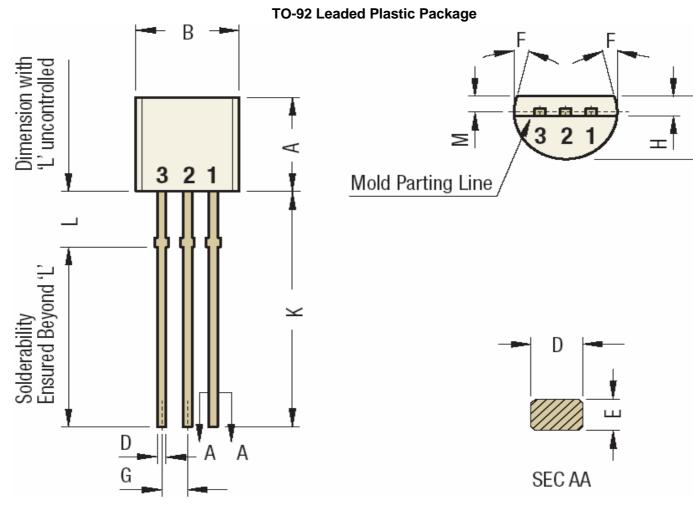
SMALL SIGNAL CHARACTERISTICS

DESCRIPTION	SYMBOL	TEST CONDITION MIN MAX		MAX	UNITS
Transistors Frequency	f _T	I _C =0.5mA, V _{CE} =3V, f=100MHz			
		BC237	TYP100		MHz
		BC238	TYP	120	MHz
		BC239 TYP140		MHz	
		I_C =10mA, V_{CE} =5V, f=100MHz	150		MHz
Collector Output Capacitance	C_{ob}	V_{CB} =10V, I_{E} =0, f=1MHz		4.5	pF
Emitter Input Capacitance	C_{ib}	V_{EB} =0.5V, f=1MHz	TYP8		pF
Noise Figure	NF	V_{CE} =5V, I_{C} =0.2mA, R_{S} =2K Ω , f =1KHz, B=200Hz			
		BC237/238	10		dB
		BC239		4.0	dB

^{*}Pulse Test: Pulse Width ≤ 300ms, Duty Cycle ≤ 2%

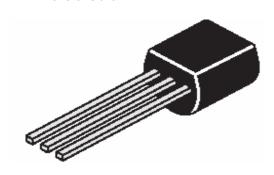
TO-92 Plastic Package

For Lead Free Parts, Device Part # will be Prefixed with "T"



DIM	Min	Max	
Α	4.32	5.33	
В	4.45	5.20	
С	3.18	4.19	
D	0.40	0.55	
Е	0.30	0.55	
F	5º		

All Dimensions are in mm



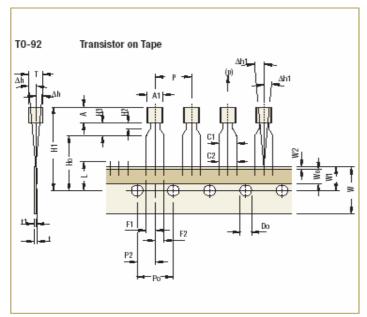
DIM Min Max G 1.14 1.40 Η 1.20 1.80 12.5 Κ 1.982 2.082 L М 1.03 1.53

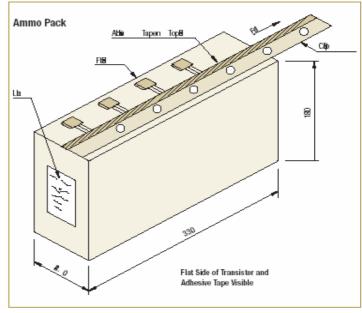
Pin 1 Emitter Pin 2 Base Pin 3 Collector

TO-92 Plastic Package

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TO-92 Tape and Ammo Packaging





All Dimensions are in mm

Tape Specifications

Item description	Symbol
Body width	A1
Body height	Α
Body thickness	T
Pitch of component ^{Cr}	P
Feed hole pitch ^{§1}	Po
Feed hole center to	
component centre§2	P2
Comp. alignment, Side view ^{§3}	Dh
Comp. alignment, Front view§3	Dh1
Tape width ^{Cr}	W
Hold down tape width ^{Cr}	Wo
Hole position	W1
Hold-down tape position	W2
Lead wire clinch height	Но
Component height	H1
Length of snipped leads	L
Feed hole diameter ^{Cr}	Do
Total tape thickness§4	t
Lead-to-lead distance ^{Cr}	F1, F2
Stand off	H2
Clinch height	Н3
Lead parallelismCr	C1-C2
Pull-out force	(p)

T0-92			
Min	Nom	Max	Tol
4.45		5.20	
4.32		5.33	
3.18		4.19	
	12.7		±1.0
	12.7		±0.3
	6.35		±0.4
	0	1.0	
	0	1.3	
	18		±0.5
	6		±0.2
	9		+0.7 -0.5
0.0		0.7	
	16		±0.5
		24.0	
		11.0	
	4		±0.2
		1.2	
2.4		2.7	
0.45		1.45	
		3.0	
		0.22	
6N			

Taping Specification

- Maximum alignment deviation between leads not to be greater than 0.20 mm.
- Maximum non-cumulative variation between tape feed holes shall not exceed 1 mm in 20 pitches.
- Hold down tape not to exceed beyond the edge(s) carrier tape and there shall be no exposure of adhesive.
- No more than 3 consecutive missing components is permitted.
- A tape trailer, having at least three feed holes is required after the last component.
- Splices shall not interfere with the sprocket feed holes.
- §1 Cumulative pitch error 1.0 mm/20 pitch.
- §2 To be measured at bottom of clinch.
- §3 At top of body.
- $\$4 \ t1 = 0.3 0.6 \ mm$
- Cr Critical Dimension.

All Dimensions are in mm

TO-92

Plastic Package

For Lead Free Parts, Device Part # will be Prefixed with "T"

Packaging Information

T & A: Tape and Ammo Pack; T & R: Tape and Red; Bulk: Loose in Poly bags; Tube: Tube and Ammo Pack; k: 1.000

Package/Case		Std. Packing		Inner Carton			Outer Cart	on
Туре	Packaging Type	Qtv	Qty	Size L x W x H	Gross Weight	Qtv	Size L x W x H	Gross Weight
Туре	Qty	Qty	(cm)	(Kg)	Qty	(cm)	(Kg)	
TO-92	Bulk	1,000	5K	19x19x8	1.10	80K	43x40x35	20.0
10-92	T&A	2,000	2K	32x4.5x20	0.70	40K	43x40x35	15.20

Component Disposal Instructions

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Customer Notes

Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.



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